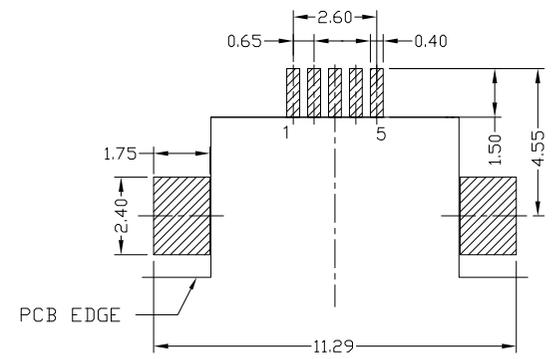
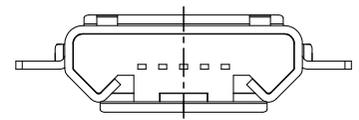
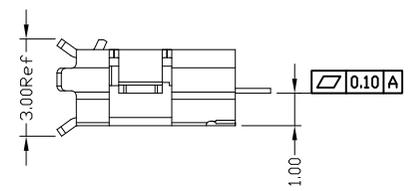
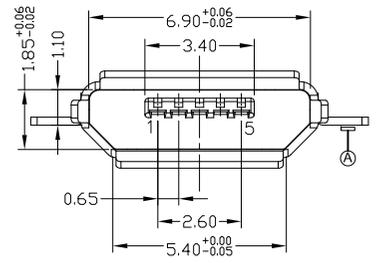
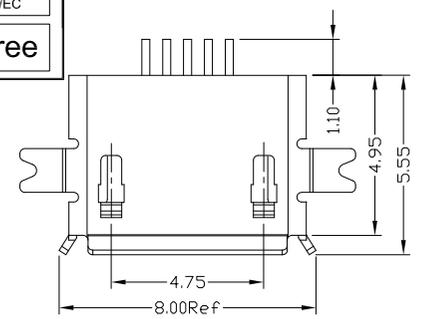
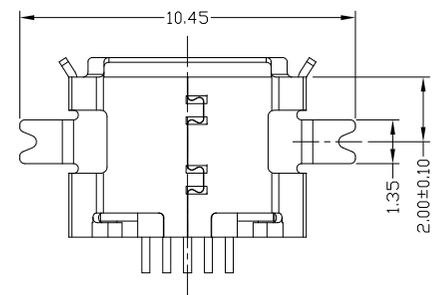


RoHS Compliant
2002/95/EC
Halogen Free

| REV. | ECN. NO. | APPD. |
|------|----------|-------|
| | | |
| | | |



RECOMMENDED PCB LAYOUT



NOTES:
 1.ELECTRICAL:
 1)VOLTAGE CURRENT RATING:PIN1&5 1.8AMP MAX
 2)PIN2&3&4 1AMP MAX. ,30V AC;
 3)INSULATION RESISTANCE: 100MΩ MIN;
 4)CONTACT RESISTANCE: 30mΩ MAX;
 5)WITHSTANDING VOLTAGE: 100V AC; FOR 1 MIN.
 2.Mechanical:
 1)Mating Force: 35N MAX
 2)Unmating Force: 10N MIN.
 3.DIMENSIONS MARKED "▼" TO BE CHECKED BY Q.C & IPQC.



4.PART NO.
 MUYF-05*T-4BHUA093
 1:Au 1U*
 6:Au 30U*
 T:TIN
 N:NICKEL
 W:WHITE
 B:BLACK
 1:PBT
 2:PA6T
 3:PA9T
 4:LCP

Bill of materials:

| | | | | | | | | | | | |
|----|----------|--------------|-----|-------------|--|---------|--------|----------|--|------|------------------|
| 3 | SHELL | COPPER ALLOY | 1 | PLATED TIN | X. ±0.35 | X.* ±2* | UNITS | mm | 东莞市铀高电子制品有限公司 TITLE: MICRO USB B TYPE F 5P SMT沉板1.0 两只脚 PART NO.: MUYF-05*T-4BHUA093 DR: Ricky 2018/5/3 DWG NO.: AII-HUA093 CHKD: Ricky 2018/5/3 APPD: | | |
| 2 | HOUSING | LCP+30%GF | 1 | UL94V-0 | .X ±0.30 | .X* ±1* | MAT'L | SEE NOTE | | | |
| 1 | TERMINAL | COPPER ALLOY | 5 | PLATED GOLD | .XX ±0.25 | .XX* | FINISH | SEE NOTE | | | |
| NO | PARTS | MATERIAL | QTY | FINISHING | .XXX ±0.15 | .XXX* | Q'TY | SEE NOTE | | | |
| | | | | | THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF ACCURATE INNDTECH AND SHALL NOT BE REPRODUCED, COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF ACCURATE INNDTECH INC | | | | | | |
| | | | | | | | | SCALE | SHEET | REV. | CUSTOMER DRAWING |
| | | | | | | | | 5:1 | 1/1 | A | |